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**Table of Contents**

3.6	Power Supply System with Embedded Voltage Regulator	68
3.7	Reset Control	69
3.7.1	Module Reset Behavior	71
3.7.2	Bootling Scheme	71
3.8	Clock Generation Unit	72
3.8.1	Recommended External Oscillator Circuits	75
3.8.2	Clock Management	77
3.9	Power Saving Modes	79
3.10	Watchdog Timer	80
3.11	Multiplication/Division Unit	83
3.12	CORDIC Coprocessor	84
3.13	UART and UART1	85
3.13.1	Baud-Rate Generator	85
3.13.2	Baud Rate Generation using Timer 1	88
3.14	Normal Divider Mode (8-bit Auto-reload Timer)	88
3.15	LIN Protocol	89
3.15.1	LIN Header Transmission	89
3.16	High-Speed Synchronous Serial Interface	91
3.17	Timer 0 and Timer 1	93
3.18	Timer 2 and Timer 21	94
3.19	Capture/Compare Unit 6	95
3.20	Controller Area Network (MultiCAN)	97
3.21	Analog-to-Digital Converter	99
3.21.1	ADC Clocking Scheme	99
3.21.2	ADC Conversion Sequence	101
3.22	On-Chip Debug Support	102
3.22.1	JTAG ID Register	103
3.23	Chip Identification Number	104
<b>4</b>	<b>Electrical Parameters</b>	<b>108</b>
4.1	General Parameters	108
4.1.1	Parameter Interpretation	108
4.1.2	Absolute Maximum Rating	109
4.1.3	Operating Conditions	110
4.2	DC Parameters	111
4.2.1	Input/Output Characteristics	111
4.2.2	Supply Threshold Characteristics	115
4.2.3	ADC Characteristics	116
4.2.3.1	ADC Conversion Timing	119
4.2.4	Power Supply Current	120
4.3	AC Parameters	124
4.3.1	Testing Waveforms	124
4.3.2	Output Rise/Fall Times	125

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**Table of Contents**

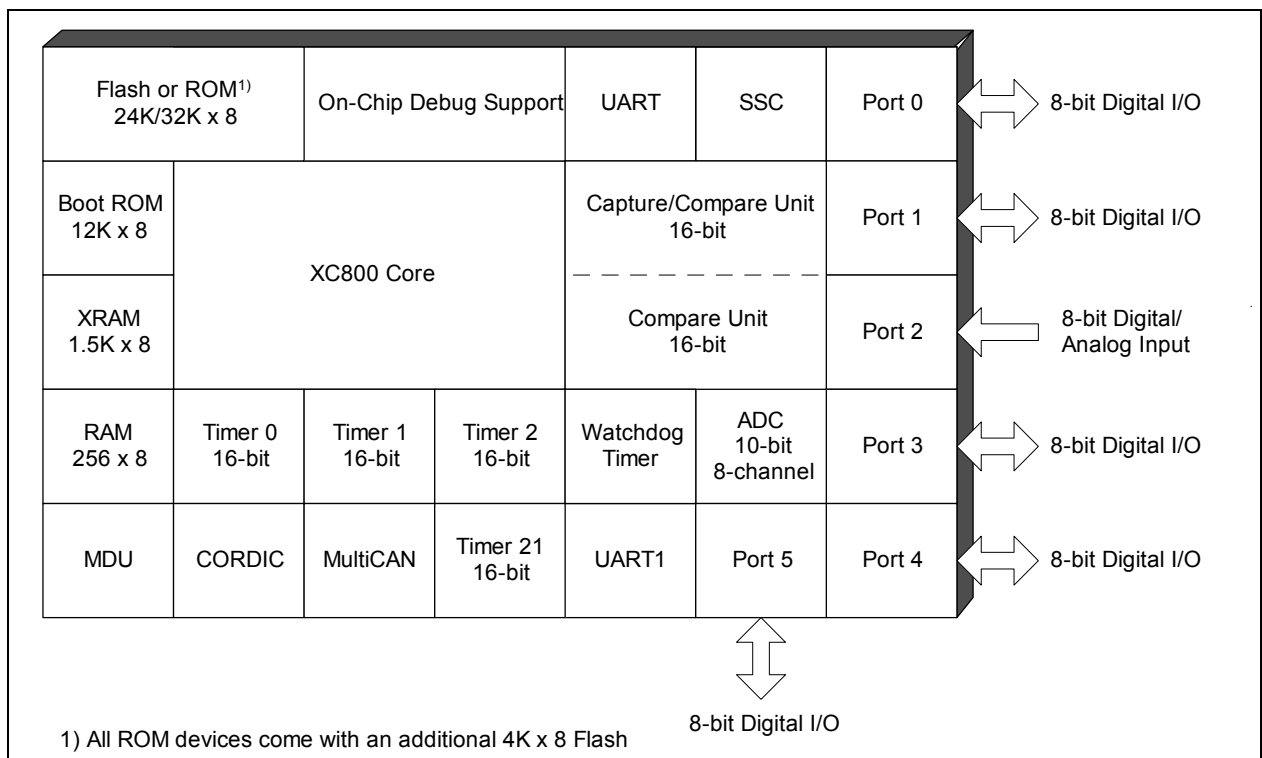
4.3.3	Power-on Reset and PLL Timing .....	126
4.3.4	On-Chip Oscillator Characteristics .....	128
4.3.5	External Clock Drive XTAL1 .....	129
4.3.6	JTAG Timing .....	130
4.3.7	SSC Master Mode Timing .....	132
<b>5</b>	<b>Package and Quality Declaration .....</b>	<b>133</b>
5.1	Package Parameters .....	133
5.2	Package Outline .....	134
5.3	Quality Declaration .....	136

# 1 Summary of Features

The XC886/888 has the following features:

- High-performance XC800 Core
  - compatible with standard 8051 processor
  - two clocks per machine cycle architecture (for memory access without wait state)
  - two data pointers
- On-chip memory
  - 12 Kbytes of Boot ROM
  - 256 bytes of RAM
  - 1.5 Kbytes of XRAM
  - 24/32 Kbytes of Flash; or  
24/32 Kbytes of ROM, with additional 4 Kbytes of Flash (includes memory protection strategy)
- I/O port supply at 3.3 V or 5.0 V and core logic supply at 2.5 V (generated by embedded voltage regulator)

(more features on next page)



**Figure 1 XC886/888 Functional Units**

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**General Device Information****Table 3 Pin Definitions and Functions (cont'd)**

Symbol	Pin Number (TQFP-48/64)	Type	Reset State	Function
P3.7	34/42		Hi-Z	EXINT4 External Interrupt Input 4 COUT63_0 Output of Capture/Compare channel 3

**Functional Description**
**Table 5 CPU Register Overview (cont'd)**

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
A8 <sub>H</sub>	<b>IEN0</b> Reset: 00 <sub>H</sub> Interrupt Enable Register 0	Bit Field	EA	0	ET2	ES	ET1	EX1	ET0	EX0
		Type	rw	r	rw	rw	rw	rw	rw	rw
B8 <sub>H</sub>	<b>IP</b> Reset: 00 <sub>H</sub> Interrupt Priority Register	Bit Field	0		PT2	PS	PT1	PX1	PT0	PX0
		Type	r		rw	rw	rw	rw	rw	rw
B9 <sub>H</sub>	<b>IPH</b> Reset: 00 <sub>H</sub> Interrupt Priority High Register	Bit Field	0		PT2H	PSH	PT1H	PX1H	PT0H	PX0H
		Type	r		rw	rw	rw	rw	rw	rw
D0 <sub>H</sub>	<b>PSW</b> Reset: 00 <sub>H</sub> Program Status Word Register	Bit Field	CY	AC	F0	RS1	RS0	OV	F1	P
		Type	rwh	rwh	rw	rw	rw	rwh	rw	rh
E0 <sub>H</sub>	<b>ACC</b> Reset: 00 <sub>H</sub> Accumulator Register	Bit Field	ACC7	ACC6	ACC5	ACC4	ACC3	ACC2	ACC1	ACC0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
E8 <sub>H</sub>	<b>IEN1</b> Reset: 00 <sub>H</sub> Interrupt Enable Register 1	Bit Field	ECCIP 3	ECCIP 2	ECCIP 1	ECCIP 0	EXM	EX2	ESSC	EADC
		Type	rw	rw	rw	rw	rw	rw	rw	rw
F0 <sub>H</sub>	<b>B</b> Register Reset: 00 <sub>H</sub>	Bit Field	B7	B6	B5	B4	B3	B2	B1	B0
		Type	rw	rw	rw	rw	rw	rw	rw	rw
F8 <sub>H</sub>	<b>IP1</b> Reset: 00 <sub>H</sub> Interrupt Priority 1 Register	Bit Field	PCCIP 3	PCCIP 2	PCCIP 1	PCCIP 0	PXM	PX2	PSSC	PADC
		Type	rw	rw	rw	rw	rw	rw	rw	rw
F9 <sub>H</sub>	<b>IPH1</b> Reset: 00 <sub>H</sub> Interrupt Priority 1 High Register	Bit Field	PCCIP 3H	PCCIP 2H	PCCIP 1H	PCCIP 0H	PXMH	PX2H	PSSC H	PADC H
		Type	rw	rw	rw	rw	rw	rw	rw	rw

**3.2.4.2 MDU Registers**

The MDU SFRs can be accessed in the mapped memory area (RMAP = 1).

**Table 6 MDU Register Overview**

Addr	Register Name	Bit	7	6	5	4	3	2	1	0	
RMAP = 1											
B0 <sub>H</sub>	<b>MDUSTAT</b> Reset: 00 <sub>H</sub> MDU Status Register	Bit Field	0					BSY	IERR	IRDY	
		Type	r					rh	rwh	rwh	
B1 <sub>H</sub>	<b>MDUCON</b> Reset: 00 <sub>H</sub> MDU Control Register	Bit Field	IE	IR	RSEL	STAR T	OPCODE				
		Type	rw	rw	rw	rwh	rw				
B2 <sub>H</sub>	<b>MD0</b> Reset: 00 <sub>H</sub> MDU Operand Register 0	Bit Field	DATA								
		Type	rw								
B2 <sub>H</sub>	<b>MR0</b> Reset: 00 <sub>H</sub> MDU Result Register 0	Bit Field	DATA								
		Type	rh								
B3 <sub>H</sub>	<b>MD1</b> Reset: 00 <sub>H</sub> MDU Operand Register 1	Bit Field	DATA								
		Type	rw								

**Functional Description**
**Table 6 MDU Register Overview (cont'd)**

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
B3 <sub>H</sub>	<b>MR1</b> <b>Reset: 00<sub>H</sub></b> MDU Result Register 1	Bit Field	DATA							
		Type	rh							
B4 <sub>H</sub>	<b>MD2</b> <b>Reset: 00<sub>H</sub></b> MDU Operand Register 2	Bit Field	DATA							
		Type	rw							
B4 <sub>H</sub>	<b>MR2</b> <b>Reset: 00<sub>H</sub></b> MDU Result Register 2	Bit Field	DATA							
		Type	rh							
B5 <sub>H</sub>	<b>MD3</b> <b>Reset: 00<sub>H</sub></b> MDU Operand Register 3	Bit Field	DATA							
		Type	rw							
B5 <sub>H</sub>	<b>MR3</b> <b>Reset: 00<sub>H</sub></b> MDU Result Register 3	Bit Field	DATA							
		Type	rh							
B6 <sub>H</sub>	<b>MD4</b> <b>Reset: 00<sub>H</sub></b> MDU Operand Register 4	Bit Field	DATA							
		Type	rw							
B6 <sub>H</sub>	<b>MR4</b> <b>Reset: 00<sub>H</sub></b> MDU Result Register 4	Bit Field	DATA							
		Type	rh							
B7 <sub>H</sub>	<b>MD5</b> <b>Reset: 00<sub>H</sub></b> MDU Operand Register 5	Bit Field	DATA							
		Type	rw							
B7 <sub>H</sub>	<b>MR5</b> <b>Reset: 00<sub>H</sub></b> MDU Result Register 5	Bit Field	DATA							
		Type	rh							

**3.2.4.3 CORDIC Registers**

The CORDIC SFRs can be accessed in the mapped memory area (RMAP = 1).

**Table 7 CORDIC Register Overview**

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
RMAP = 1										
9A <sub>H</sub>	<b>CD_CORDXL</b> <b>Reset: 00<sub>H</sub></b> CORDIC X Data Low Byte	Bit Field	DATA							
		Type	rw							
9B <sub>H</sub>	<b>CD_CORDXH</b> <b>Reset: 00<sub>H</sub></b> CORDIC X Data High Byte	Bit Field	DATA							
		Type	rw							
9C <sub>H</sub>	<b>CD_CORDYL</b> <b>Reset: 00<sub>H</sub></b> CORDIC Y Data Low Byte	Bit Field	DATA							
		Type	rw							
9D <sub>H</sub>	<b>CD_CORDYH</b> <b>Reset: 00<sub>H</sub></b> CORDIC Y Data High Byte	Bit Field	DATA							
		Type	rw							
9E <sub>H</sub>	<b>CD_CORDZL</b> <b>Reset: 00<sub>H</sub></b> CORDIC Z Data Low Byte	Bit Field	DATA							
		Type	rw							
9F <sub>H</sub>	<b>CD_CORDZH</b> <b>Reset: 00<sub>H</sub></b> CORDIC Z Data High Byte	Bit Field	DATA							
		Type	rw							

**Functional Description**
**Table 14 CCU6 Register Overview (cont'd)**

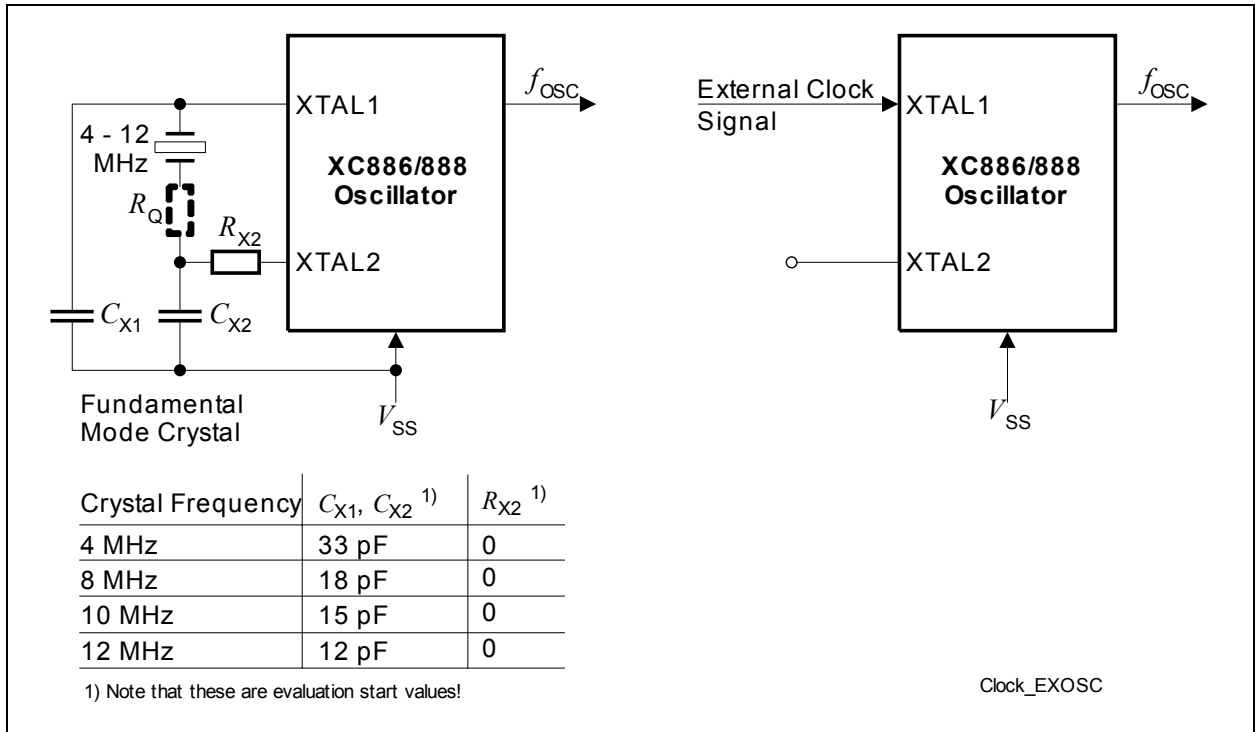
Addr	Register Name	Bit	7	6	5	4	3	2	1	0
FA <sub>H</sub>	<b>CCU6_CC60SRL</b> <b>Reset: 00<sub>H</sub></b> Capture/Compare Shadow Register for Channel CC60 Low	Bit Field	CC60SL							
		Type	rwh							
FB <sub>H</sub>	<b>CCU6_CC60SRH</b> <b>Reset: 00<sub>H</sub></b> Capture/Compare Shadow Register for Channel CC60 High	Bit Field	CC60SH							
		Type	rwh							
FC <sub>H</sub>	<b>CCU6_CC61SRL</b> <b>Reset: 00<sub>H</sub></b> Capture/Compare Shadow Register for Channel CC61 Low	Bit Field	CC61SL							
		Type	rwh							
FD <sub>H</sub>	<b>CCU6_CC61SRH</b> <b>Reset: 00<sub>H</sub></b> Capture/Compare Shadow Register for Channel CC61 High	Bit Field	CC61SH							
		Type	rwh							
FE <sub>H</sub>	<b>CCU6_CC62SRL</b> <b>Reset: 00<sub>H</sub></b> Capture/Compare Shadow Register for Channel CC62 Low	Bit Field	CC62SL							
		Type	rwh							
FF <sub>H</sub>	<b>CCU6_CC62SRH</b> <b>Reset: 00<sub>H</sub></b> Capture/Compare Shadow Register for Channel CC62 High	Bit Field	CC62SH							
		Type	rwh							
RMAP = 0, PAGE 1										
9A <sub>H</sub>	<b>CCU6_CC63RL</b> <b>Reset: 00<sub>H</sub></b> Capture/Compare Register for Channel CC63 Low	Bit Field	CC63VL							
		Type	rh							
9B <sub>H</sub>	<b>CCU6_CC63RH</b> <b>Reset: 00<sub>H</sub></b> Capture/Compare Register for Channel CC63 High	Bit Field	CC63VH							
		Type	rh							
9C <sub>H</sub>	<b>CCU6_T12PRL</b> <b>Reset: 00<sub>H</sub></b> Timer T12 Period Register Low	Bit Field	T12PVL							
		Type	rwh							
9D <sub>H</sub>	<b>CCU6_T12PRH</b> <b>Reset: 00<sub>H</sub></b> Timer T12 Period Register High	Bit Field	T12PVH							
		Type	rwh							
9E <sub>H</sub>	<b>CCU6_T13PRL</b> <b>Reset: 00<sub>H</sub></b> Timer T13 Period Register Low	Bit Field	T13PVL							
		Type	rwh							
9F <sub>H</sub>	<b>CCU6_T13PRH</b> <b>Reset: 00<sub>H</sub></b> Timer T13 Period Register High	Bit Field	T13PVH							
		Type	rwh							
A4 <sub>H</sub>	<b>CCU6_T12DTCL</b> <b>Reset: 00<sub>H</sub></b> Dead-Time Control Register for Timer T12 Low	Bit Field	DTM							
		Type	rw							
A5 <sub>H</sub>	<b>CCU6_T12DTCH</b> <b>Reset: 00<sub>H</sub></b> Dead-Time Control Register for Timer T12 High	Bit Field	0	DTR2	DTR1	DTR0	0	DTE2	DTE1	DTE0
		Type	r	rh	rh	rh	r	rw	rw	rw
A6 <sub>H</sub>	<b>CCU6_TCTR0L</b> <b>Reset: 00<sub>H</sub></b> Timer Control Register 0 Low	Bit Field	CTM	CDIR	STE1 2	T12R	T12 PRE	T12CLK		
		Type	rw	rh	rh	rh	rw	rw		
A7 <sub>H</sub>	<b>CCU6_TCTR0H</b> <b>Reset: 00<sub>H</sub></b> Timer Control Register 0 High	Bit Field	0		STE1 3	T13R	T13 PRE	T13CLK		
		Type	r		rh	rh	rw	rw		
FA <sub>H</sub>	<b>CCU6_CC60RL</b> <b>Reset: 00<sub>H</sub></b> Capture/Compare Register for Channel CC60 Low	Bit Field	CC60VL							
		Type	rh							



**Functional Description**
**Table 14 CCU6 Register Overview (cont'd)**

Addr	Register Name	Bit	7	6	5	4	3	2	1	0
FB <sub>H</sub>	<b>CCU6_TCTR2H</b> Reset: 00 <sub>H</sub> Timer Control Register 2 High	Bit Field	0				T13RSEL		T12RSEL	
		Type	r				rw		rw	
FC <sub>H</sub>	<b>CCU6_MODCTRL</b> Reset: 00 <sub>H</sub> Modulation Control Register Low	Bit Field	MCM EN	0	T12MODEN					
		Type	rw	r	rw					
FD <sub>H</sub>	<b>CCU6_MODCTRH</b> Reset: 00 <sub>H</sub> Modulation Control Register High	Bit Field	ECT1 30	0	T13MODEN					
		Type	rw	r	rw					
FE <sub>H</sub>	<b>CCU6_TRPCTRL</b> Reset: 00 <sub>H</sub> Trap Control Register Low	Bit Field	0				TRPM 2	TRPM 1	TRPM 0	
		Type	r				rw	rw	rw	
FF <sub>H</sub>	<b>CCU6_TRPCTRH</b> Reset: 00 <sub>H</sub> Trap Control Register High	Bit Field	TRPP EN	TRPE N13	TRPEN					
		Type	rw	rw	rw					
RMAP = 0, PAGE 3										
9A <sub>H</sub>	<b>CCU6_MCMOUTL</b> Reset: 00 <sub>H</sub> Multi-Channel Mode Output Register Low	Bit Field	0	R	MCMP					
		Type	r	rh	rh					
9B <sub>H</sub>	<b>CCU6_MCMOUTH</b> Reset: 00 <sub>H</sub> Multi-Channel Mode Output Register High	Bit Field	0		CURH			EXPH		
		Type	r		rh			rh		
9C <sub>H</sub>	<b>CCU6_ISL</b> Reset: 00 <sub>H</sub> Capture/Compare Interrupt Status Register Low	Bit Field	T12 PM	T12 OM	ICC62 F	ICC62 R	ICC61 F	ICC61 R	ICC60 F	ICC60 R
		Type	rh	rh	rh	rh	rh	rh	rh	rh
9D <sub>H</sub>	<b>CCU6_ISH</b> Reset: 00 <sub>H</sub> Capture/Compare Interrupt Status Register High	Bit Field	STR	IDLE	WHE	CHE	TRPS	TRPF	T13 PM	T13 CM
		Type	rh	rh	rh	rh	rh	rh	rh	rh
9E <sub>H</sub>	<b>CCU6_PISEL0L</b> Reset: 00 <sub>H</sub> Port Input Select Register 0 Low	Bit Field	ISTRP		ISCC62		ISCC61		ISCC60	
		Type	rw		rw		rw		rw	
9F <sub>H</sub>	<b>CCU6_PISEL0H</b> Reset: 00 <sub>H</sub> Port Input Select Register 0 High	Bit Field	IST12HR		ISPOS2		ISPOS1		ISPOS0	
		Type	rw		rw		rw		rw	
A4 <sub>H</sub>	<b>CCU6_PISEL2</b> Reset: 00 <sub>H</sub> Port Input Select Register 2	Bit Field	0						IST13HR	
		Type	r						rw	
FA <sub>H</sub>	<b>CCU6_T12L</b> Reset: 00 <sub>H</sub> Timer T12 Counter Register Low	Bit Field	T12CVL							
		Type	rwh							
FB <sub>H</sub>	<b>CCU6_T12H</b> Reset: 00 <sub>H</sub> Timer T12 Counter Register High	Bit Field	T12CVH							
		Type	rwh							
FC <sub>H</sub>	<b>CCU6_T13L</b> Reset: 00 <sub>H</sub> Timer T13 Counter Register Low	Bit Field	T13CVL							
		Type	rwh							
FD <sub>H</sub>	<b>CCU6_T13H</b> Reset: 00 <sub>H</sub> Timer T13 Counter Register High	Bit Field	T13CVH							
		Type	rwh							

Functional Description



**Figure 25 External Oscillator Circuitry**

*Note: For crystal operation, it is strongly recommended to measure the negative resistance in the final target system (layout) to determine the optimum parameters for the oscillator operation. Please refer to the minimum and maximum values of the negative resistance specified by the crystal supplier.*

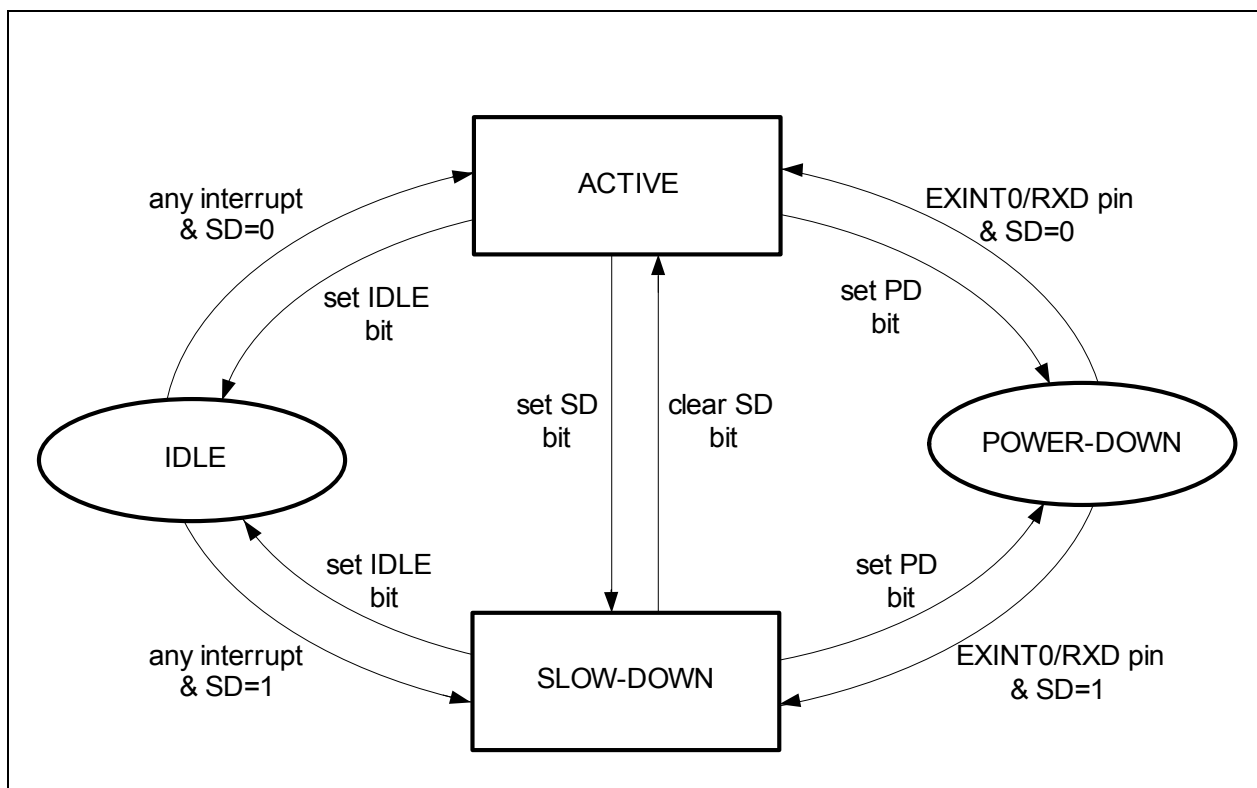
### 3.9 Power Saving Modes

The power saving modes of the XC886/888 provide flexible power consumption through a combination of techniques, including:

- Stopping the CPU clock
- Stopping the clocks of individual system components
- Reducing clock speed of some peripheral components
- Power-down of the entire system with fast restart capability

After a reset, the active mode (normal operating mode) is selected by default (see [Figure 27](#)) and the system runs in the main system clock frequency. From active mode, different power saving modes can be selected by software. They are:

- Idle mode
- Slow-down mode
- Power-down mode



**Figure 27 Transition between Power Saving Modes**

### 3.10 Watchdog Timer

The Watchdog Timer (WDT) provides a highly reliable and secure way to detect and recover from software or hardware failures. The WDT is reset at a regular interval that is predefined by the user. The CPU must service the WDT within this interval to prevent the WDT from causing an XC886/888 system reset. Hence, routine service of the WDT confirms that the system is functioning properly. This ensures that an accidental malfunction of the XC886/888 will be aborted in a user-specified time period.

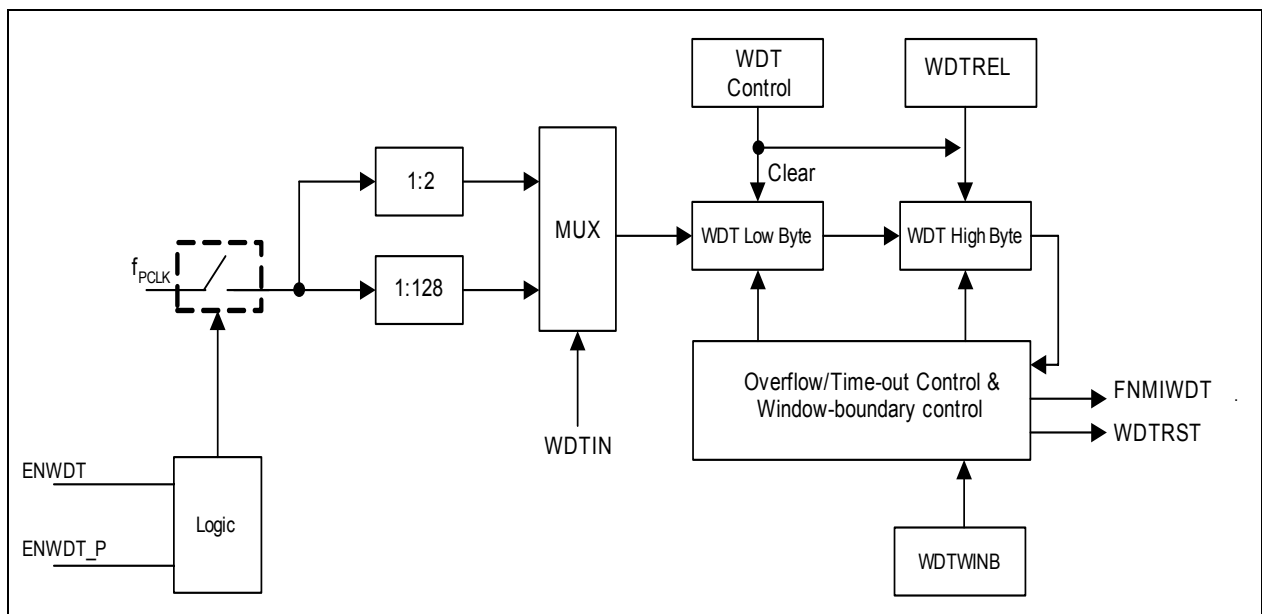
In debug mode, the WDT is default suspended and stops counting. Therefore, there is no need to refresh the WDT during debugging.

#### Features

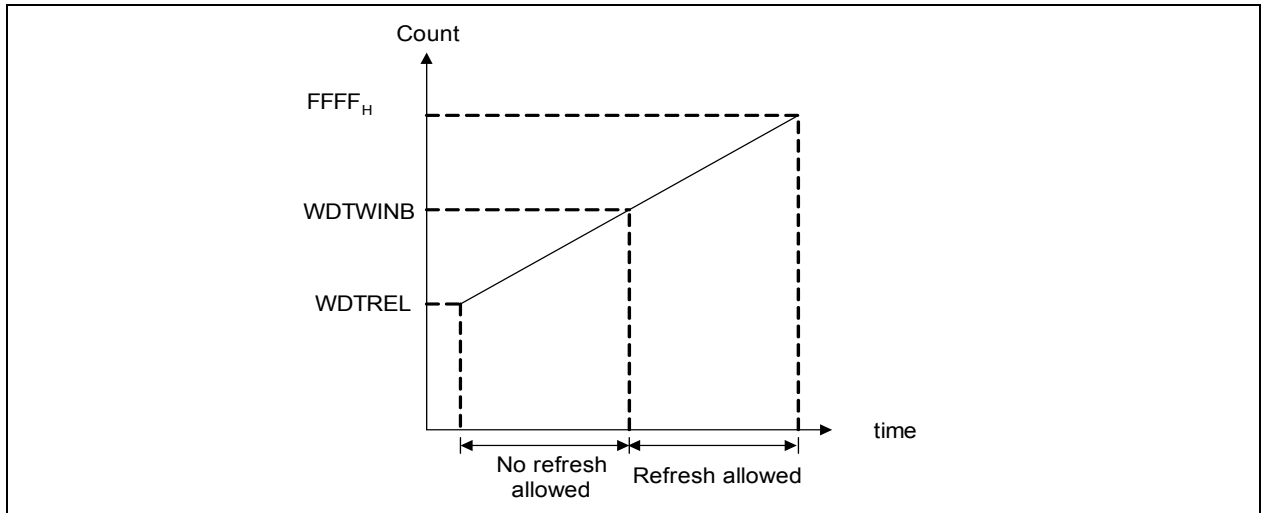
- 16-bit Watchdog Timer
- Programmable reload value for upper 8 bits of timer
- Programmable window boundary
- Selectable input frequency of  $f_{PCLK}/2$  or  $f_{PCLK}/128$
- Time-out detection with NMI generation and reset prewarning activation (after which a system reset will be performed)

The WDT is a 16-bit timer incremented by a count rate of  $f_{PCLK}/2$  or  $f_{PCLK}/128$ . This 16-bit timer is realized as two concatenated 8-bit timers. The upper 8 bits of the WDT can be preset to a user-programmable value via a watchdog service access in order to modify the watchdog expire time period. The lower 8 bits are reset on each service access.

**Figure 28** shows the block diagram of the WDT unit.



**Figure 28 WDT Block Diagram**



**Figure 29 WDT Timing Diagram**

**Table 27** lists the possible watchdog time ranges that can be achieved using a certain module clock. Some numbers are rounded to 3 significant digits.

**Table 27 Watchdog Time Ranges**

Reload value In WDTREL	Prescaler for $f_{PCLK}$	
	2 (WDTIN = 0)	128 (WDTIN = 1)
	24 MHz	24 MHz
FF <sub>H</sub>	21.3 $\mu$ s	1.37 ms
7F <sub>H</sub>	2.75 ms	176 ms
00 <sub>H</sub>	5.46 ms	350 ms

Functional Description

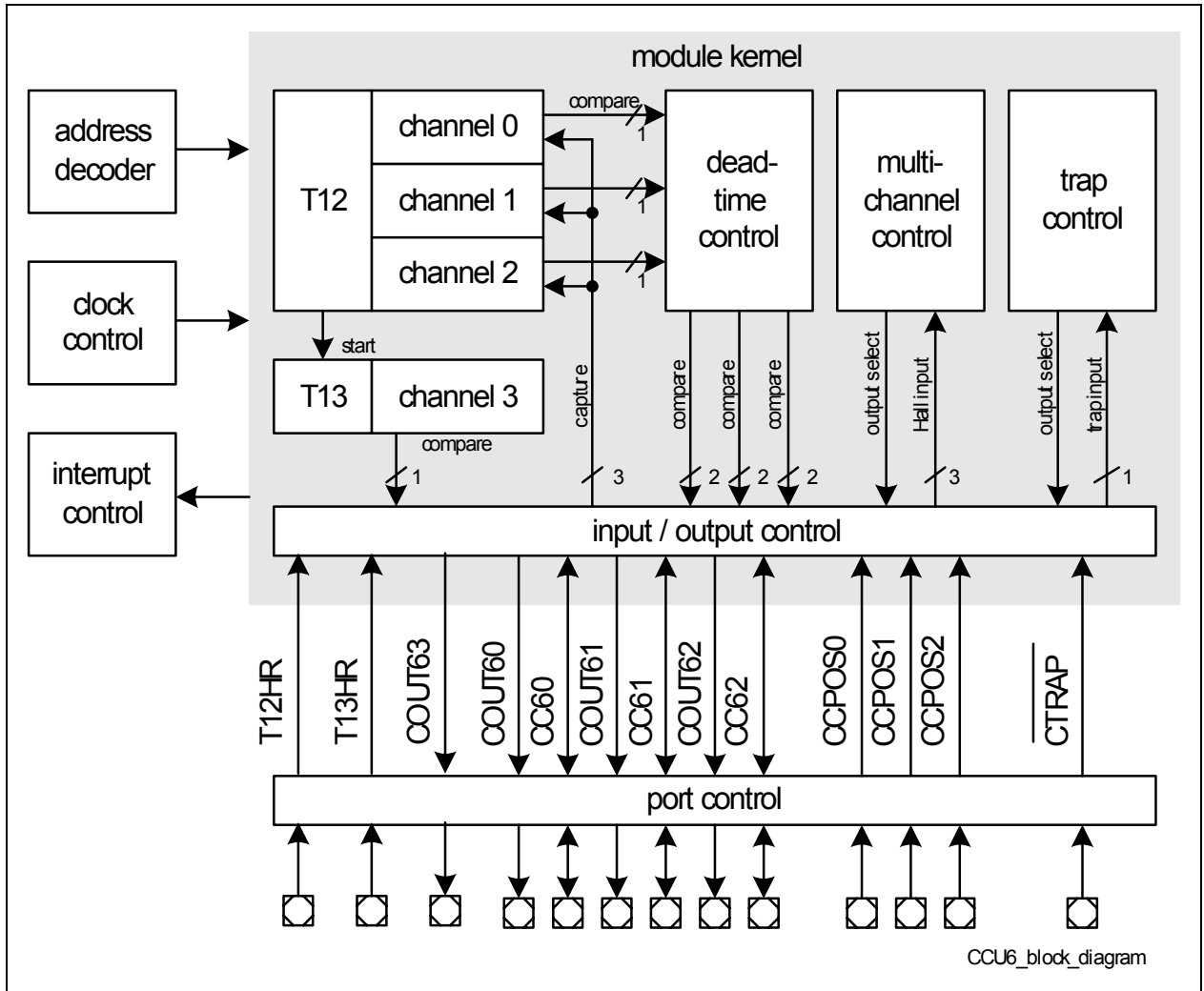
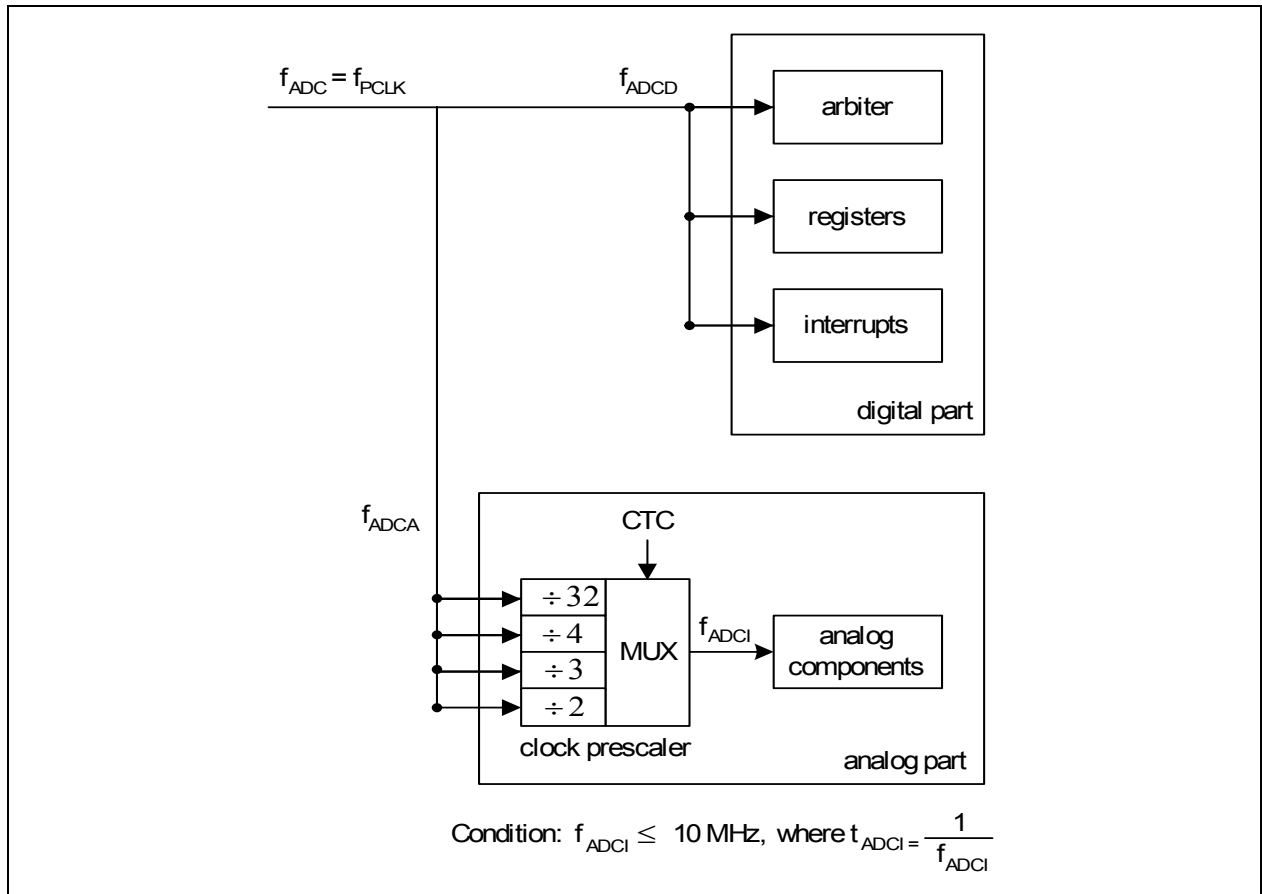


Figure 33 CCU6 Block Diagram

Functional Description

GLOBCTR. A prescaling ratio of 32 can be selected when the maximum performance of the ADC is not required.



**Figure 35 ADC Clocking Scheme**

For module clock  $f_{ADC} = 24 \text{ MHz}$ , the analog clock  $f_{ADCL}$  frequency can be selected as shown in [Table 34](#).

**Table 34  $f_{ADCL}$  Frequency Selection**

Module Clock $f_{ADC}$	CTC	Prescaling Ratio	Analog Clock $f_{ADCL}$
24 MHz	00 <sub>B</sub>	÷ 2	12 MHz (N.A)
	01 <sub>B</sub>	÷ 3	8 MHz
	10 <sub>B</sub>	÷ 4	6 MHz
	11 <sub>B</sub> (default)	÷ 32	750 kHz

As  $f_{ADCL}$  cannot exceed 10 MHz, bit field CTC should not be set to 00<sub>B</sub> when  $f_{ADC}$  is 24 MHz. During slow-down mode where  $f_{ADC}$  may be reduced to 12 MHz, 6 MHz etc., CTC can be set to 00<sub>B</sub> as long as the divided analog clock  $f_{ADCL}$  does not exceed 10 MHz.

Functional Description

**Table 36** Chip Identification Number (cont'd)

Product Variant	Chip Identification Number		
	AA-Step	AB-Step	AC-Step
XC888CM-6RFA 5V	22891503 <sub>H</sub>	-	-
XC886C-6RFA 5V	22891542 <sub>H</sub>	-	-
XC888C-6RFA 5V	22891543 <sub>H</sub>	-	-
XC886-6RFA 5V	22891562 <sub>H</sub>	-	-
XC888-6RFA 5V	22891563 <sub>H</sub>	-	-



### 4.1.3 Operating Conditions

The following operating conditions must not be exceeded in order to ensure correct operation of the XC886/888. All parameters mentioned in the following table refer to these operating conditions, unless otherwise noted.

**Table 37 Operating Condition Parameters**

Parameter	Symbol	Limit Values		Unit	Notes/ Conditions
		min.	max.		
Digital power supply voltage	$V_{DDP}$	4.5	5.5	V	5V Device
Digital power supply voltage	$V_{DDP}$	3.0	3.6	V	3.3V Device
Digital ground voltage	$V_{SS}$	0		V	
Digital core supply voltage	$V_{DDC}$	2.3	2.7	V	
System Clock Frequency <sup>1)</sup>	$f_{SYS}$	88.8	103.2	MHz	
Ambient temperature	$T_A$	-40	85	°C	SAF- XC886/888...
		-40	125	°C	SAK- XC886/888...

1)  $f_{SYS}$  is the PLL output clock. During normal operating mode, CPU clock is  $f_{SYS} / 4$ . Please refer to [Figure 26](#) for detailed description.

**Electrical Parameters**
**Table 43 Power Supply Current Parameters (Operating Conditions apply;  
 $V_{DDP} = 3.3V$  range)**

Parameter	Symbol	Limit Values		Unit	Test Condition
		typ. <sup>1)</sup>	max. <sup>2)</sup>		
<b><math>V_{DDP} = 3.3V</math> Range</b>					
Active Mode	$I_{DDP}$	25.6	31.0	mA	Flash Device <sup>3)</sup>
		23.4	28.6	mA	ROM Device <sup>3)</sup>
Idle Mode	$I_{DDP}$	19.9	24.7	mA	Flash Device <sup>4)</sup>
		17.5	20.7	mA	ROM Device <sup>4)</sup>
Active Mode with slow-down enabled	$I_{DDP}$	13.3	16.2	mA	Flash Device <sup>5)</sup>
		11.5	13.7	mA	ROM Device <sup>5)</sup>
Idle Mode with slow-down enabled	$I_{DDP}$	11.1	14.4	mA	Flash Device <sup>6)</sup>
		9.3	11.4	mA	ROM Device <sup>6)</sup>

1) The typical  $I_{DDP}$  values are periodically measured at  $T_A = +25\text{ °C}$  and  $V_{DDP} = 3.3\text{ V}$ .

2) The maximum  $I_{DDP}$  values are measured under worst case conditions ( $T_A = +125\text{ °C}$  and  $V_{DDP} = 3.6\text{ V}$ ).

3)  $I_{DDP}$  (active mode) is measured with: CPU clock and input clock to all peripherals running at 24 MHz (set by on-chip oscillator of 9.6 MHz and NDIV in PLL\_CON to 1001<sub>B</sub>),  $\overline{\text{RESET}} = V_{DDP}$ , no load on ports.

4)  $I_{DDP}$  (idle mode) is measured with: CPU clock disabled, watchdog timer disabled, input clock to all peripherals enabled and running at 24 MHz,  $\overline{\text{RESET}} = V_{DDP}$ , no load on ports.

5)  $I_{DDP}$  (active mode with slow-down mode) is measured with: CPU clock and input clock to all peripherals running at 8 MHz by setting CLKREL in CMCON to 0110<sub>B</sub>,  $\overline{\text{RESET}} = V_{DDP}$ , no load on ports.

6)  $I_{DDP}$  (idle mode with slow-down mode) is measured with: CPU clock disabled, watchdog timer disabled, input clock to all peripherals enabled and running at 8 MHz by setting CLKREL in CMCON to 0110<sub>B</sub>,  $\overline{\text{RESET}} = V_{DDP}$ , no load on ports.

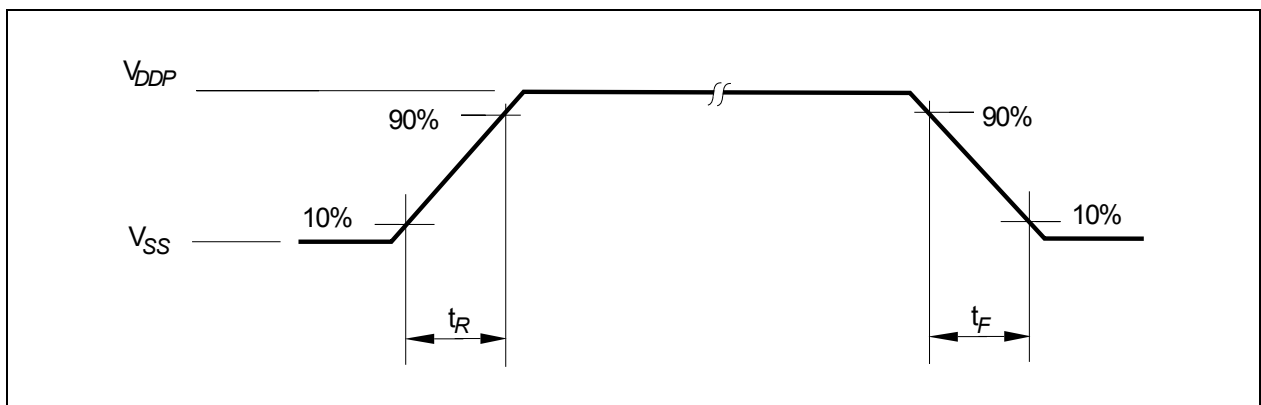
### 4.3.2 Output Rise/Fall Times

Table 45 provides the characteristics of the output rise/fall times in the XC886/888.

**Table 45 Output Rise/Fall Times Parameters (Operating Conditions apply)**

Parameter	Symbol	Limit Values		Unit	Test Conditions
		min.	max.		
<b><math>V_{DDP} = 5V</math> Range</b>					
Rise/fall times	$t_R, t_F$	–	10	ns	20 pF. <sup>1)2)3)</sup>
<b><math>V_{DDP} = 3.3V</math> Range</b>					
Rise/fall times	$t_R, t_F$	–	10	ns	20 pF. <sup>1)2)4)</sup>

- 1) Rise/Fall time measurements are taken with 10% - 90% of pad supply.
- 2) Not all parameters are 100% tested, but are verified by design/characterization and test correlation.
- 3) Additional rise/fall time valid for  $C_L = 20pF - 100pF @ 0.125 ns/pF$ .
- 4) Additional rise/fall time valid for  $C_L = 20pF - 100pF @ 0.225 ns/pF$ .



**Figure 43 Rise/Fall Times Parameters**

## 5.2 Package Outline

Figure 48 shows the package outlines of the XC886.

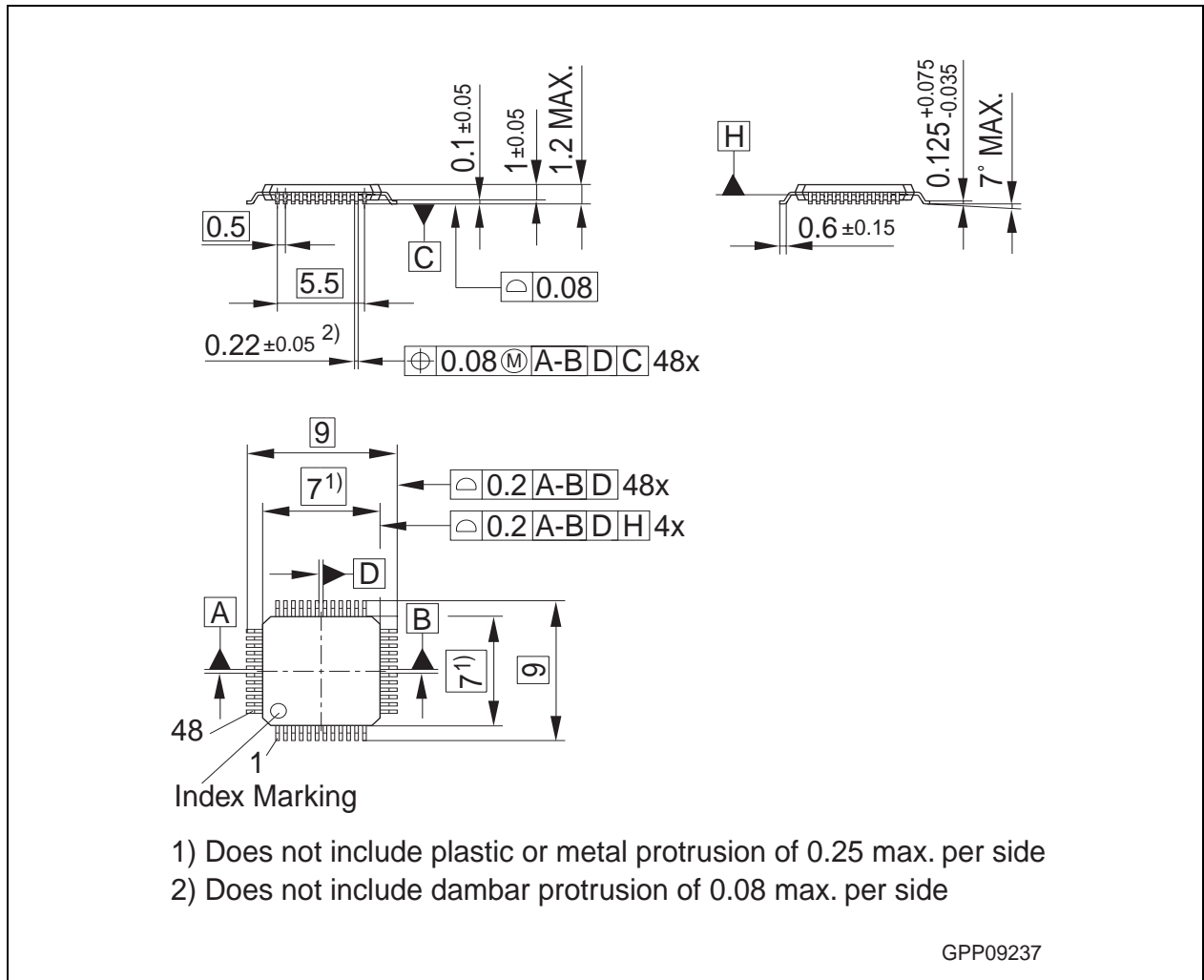


Figure 48 PG-TQFP-48 Package Outline

Package and Quality Declaration

Figure 49 shows the package outlines of the XC888.

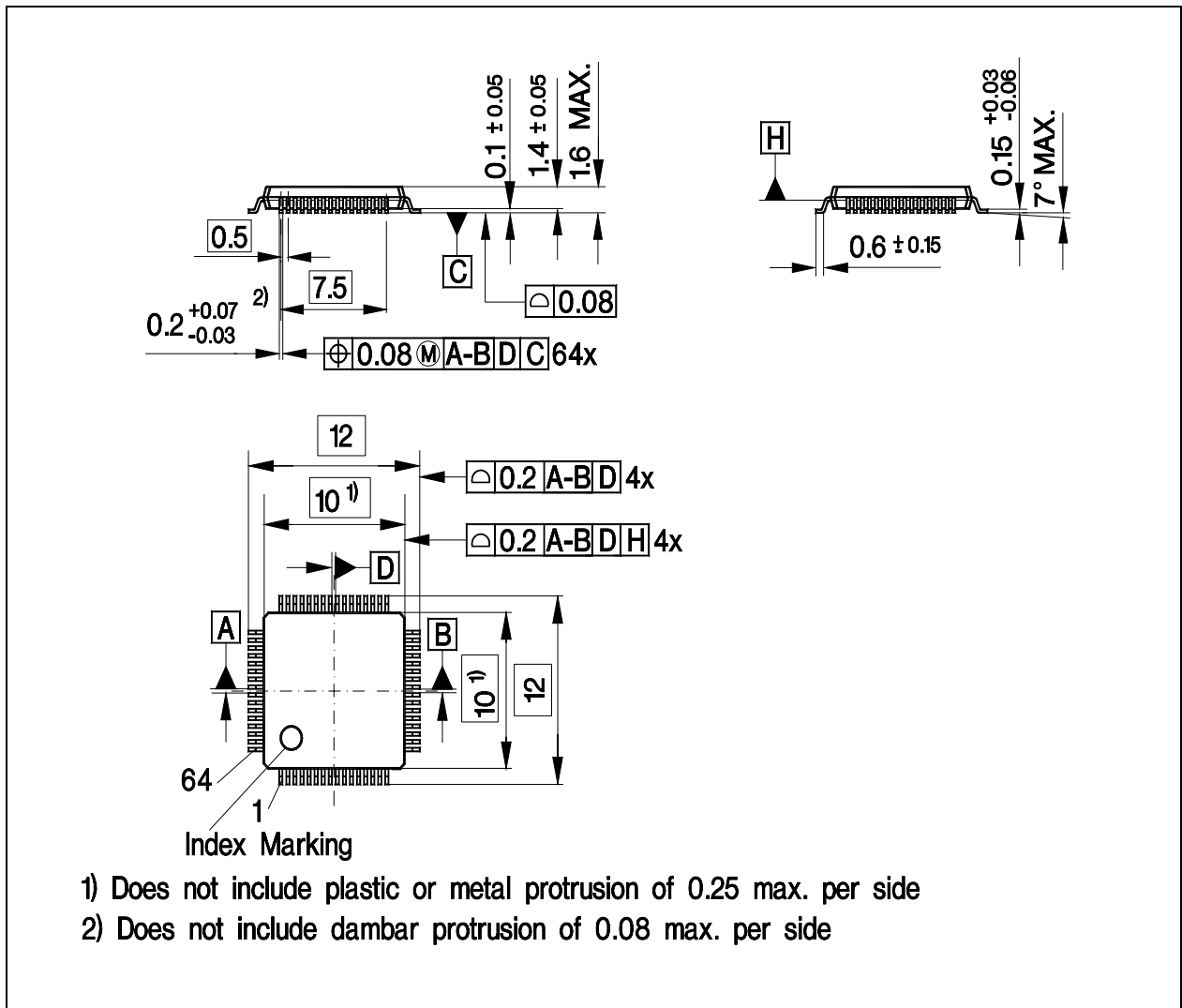


Figure 49 PG-TQFP-64 Package Outline